International Workshop on Radiation Imaging Detectors iWoRID 2011

Monday 4 July 2011

Sensor Materials, Device Processing & Technologies II: 2 contributions - HG E7 (16:25 - 17:40)

-Conveners: Val O'Shea

time	[id] title	presenter
16:25	[9] Wafer Level 3D Integration Technologies	FRITZSCH, Thomas
	[126] Cadmium Telluride pixel sensor development for high sensibility X-ray imaging device	Dr TOYOKAWA, Hidenori
17:20	[120] CdTe Medipix2 and Medipix3 Pixel Detectors: Material Characterization, Technology and Device Performance	Dr FIEDERLE, Michael